

Description

The LM3L7P02 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = -20V$ $I_D = -7A$

$R_{DS(ON)} < 25m\Omega$ @ $V_{GS} = -4.5V$ (Typ.20m Ω)

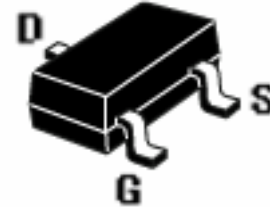
Application

- Quick charge
- electronic cigarette
- Uninterruptible power supply

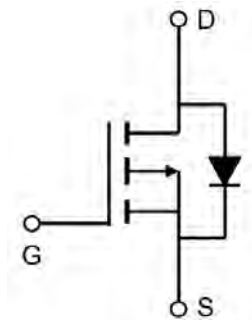
Package Marking and Ordering Information

Device	Device Marking	Device Package	Reel Size	Tape width	Quantity
LM3L7P02	2307A	SOT-23	Ø180mm	8mm	3000 units

Dimensions SOT-23



Pin Configuration



Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-20	V
V_{GS}	Gate-Source Voltage	± 12	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -4.5V^1$	-7	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ -4.5V^1$	-4.8	A
I_{DM}	Pulsed Drain Current ²	-23.8	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation ³	2	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$
$R_{\theta JA}$	Thermal Resistance Junction-ambient ¹	62.5	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	80	$^\circ C/W$

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D = -250\mu A$	-20	-22	-	V
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -20V, V_{GS}=0V,$	-	-	-1	μA
IGSS	Gate to Body Leakage Current	$V_{DS}=0V, V_{GS}= \pm 12V$	-	-	± 100	nA
VGS(th)	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D = -250\mu A$	-0.5	-0.7	-1.2	V
RDS(on)	Static Drain-Source on-Resistance note2	$V_{GS} = -4.5V, I_D = -6A$	-	20	25	m Ω
		$V_{GS} = -2.5V, I_D = -5A$	-	28	35	
C _{iss}	Input Capacitance	$V_{DS} = -10V, V_{GS}=0V,$ $f=1.0MHz$	-	2000	-	pF
C _{oss}	Output Capacitance		-	242	-	pF
C _{rss}	Reverse Transfer Capacitance		-	231	-	pF
Q _g	Total Gate Charge	$V_{DS} = -10V, I_D = -3A,$ $V_{GS} = -4.5V$	-	15.3	-	nC
Q _{gs}	Gate-Source Charge		-	2.2	-	nC
Q _{gd}	Gate-Drain("Miller") Charge		-	4.4	-	nC
td(on)	Turn-on Delay Time	$V_{DD} = -10V, I_D = -7A,$ $V_{GS} = -4.5V,$ $R_{GEN}=2.5\Omega$	-	10	-	ns
t _r	Turn-on Rise Time		-	31	-	ns
td(off)	Turn-off Delay Time		-	28	-	ns
t _f	Turn-off Fall Time		-	8	-	ns
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	-7	A
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-28	A
VSD	Drain to Source Diode Forward Voltage	$V_{GS}=0V, I_S = -7A$	-	-0.8	-1.2	V

Note :

- 1、 The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- 3、 The power dissipation is limited by 150 $^{\circ}\text{C}$ junction temperature
- 4、 The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Typical Characteristics

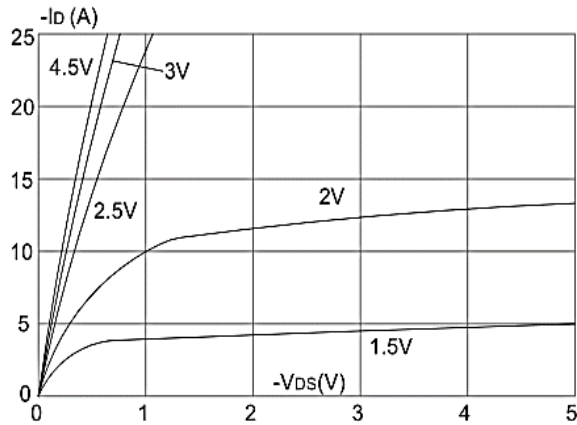


Figure1: Output Characteristics

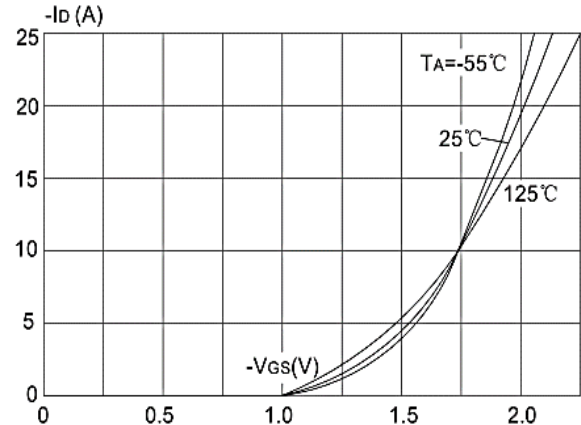


Figure 2: Typical Transfer Characteristics

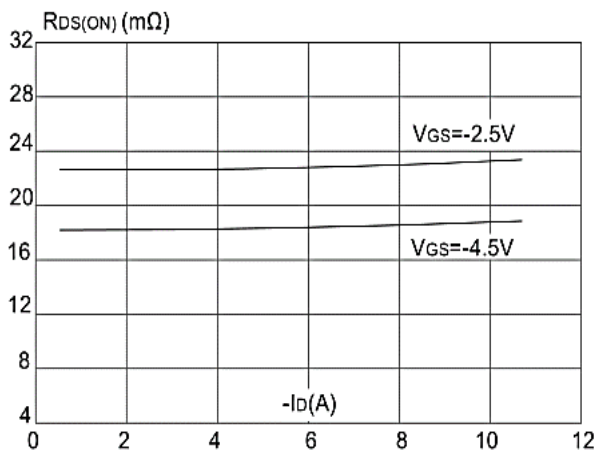


Figure 3: On-resistance vs. Drain Current

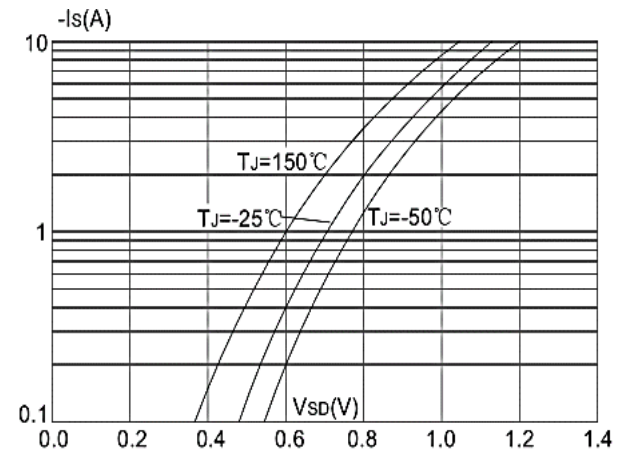


Figure 4: Body Diode Characteristics

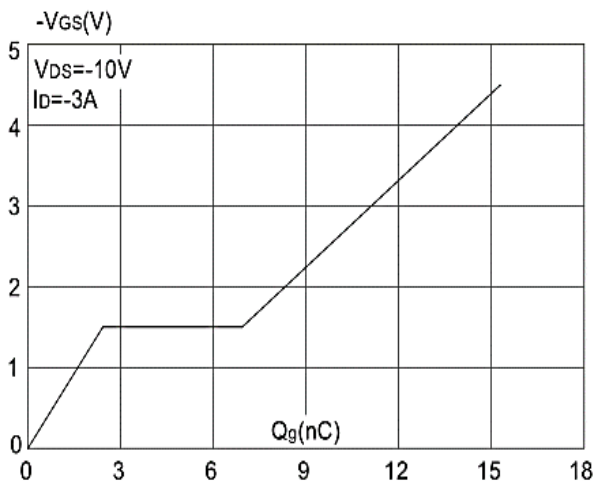


Figure 5: Gate Charge Characteristics

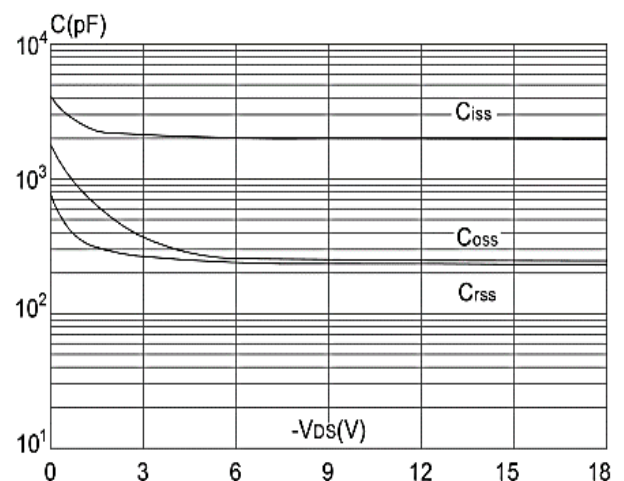


Figure 6: Capacitance Characteristics

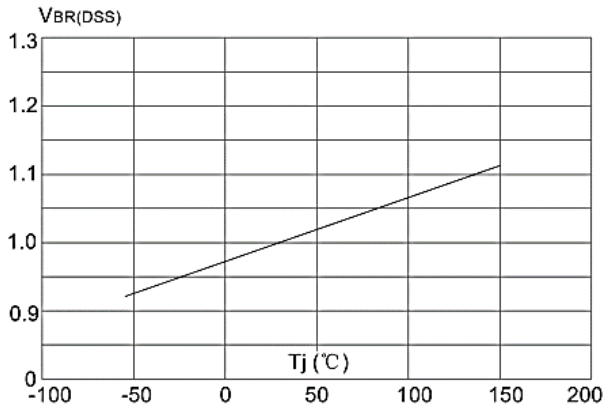


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

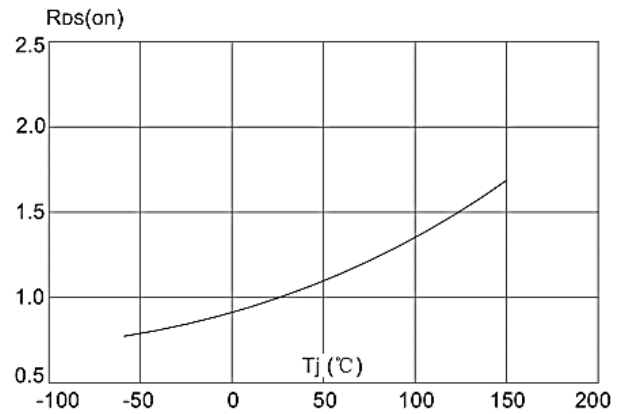


Figure 8: Normalized on Resistance vs. Junction Temperature

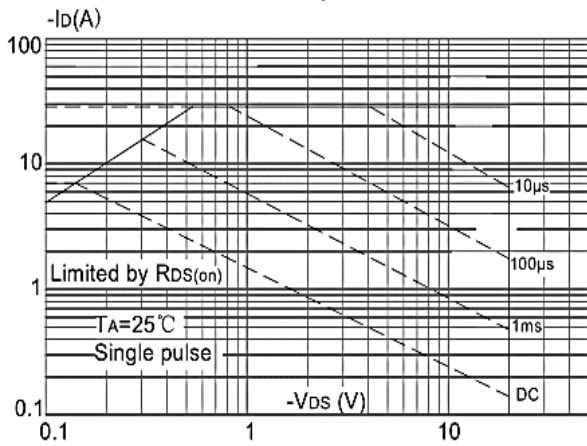


Figure 9: Maximum Safe Operating Area vs. Case Temperature

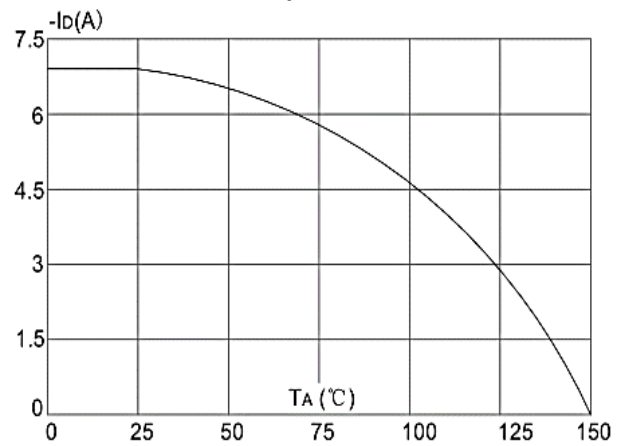


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

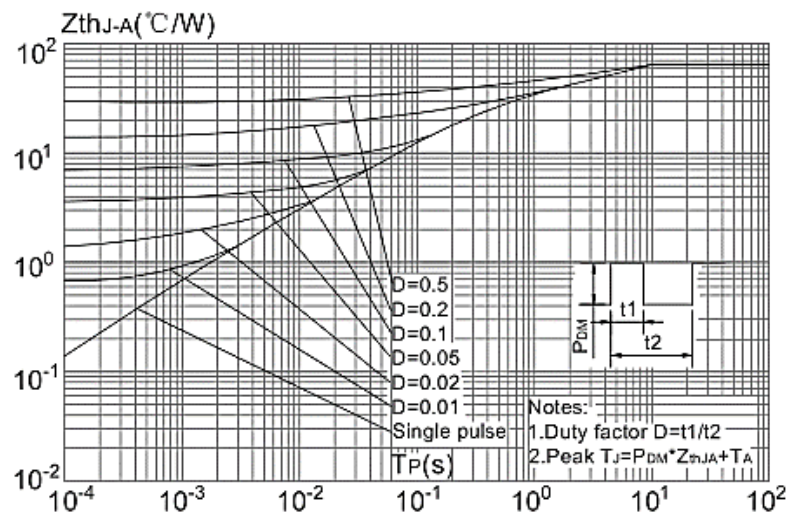
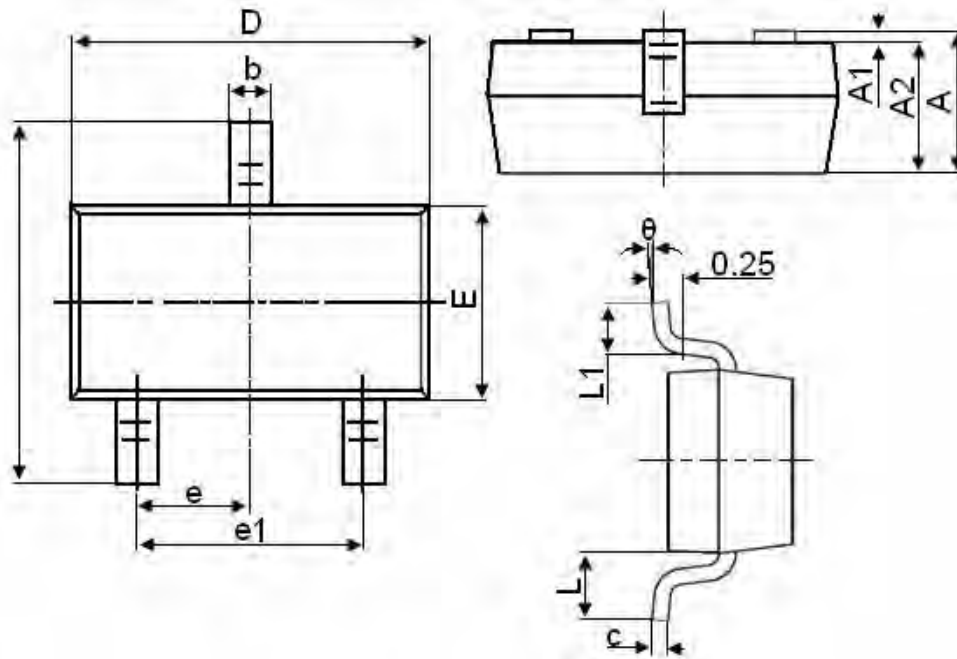


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

SOT-23 Package Information



Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°